

PRELIMINARY SPEC

Features

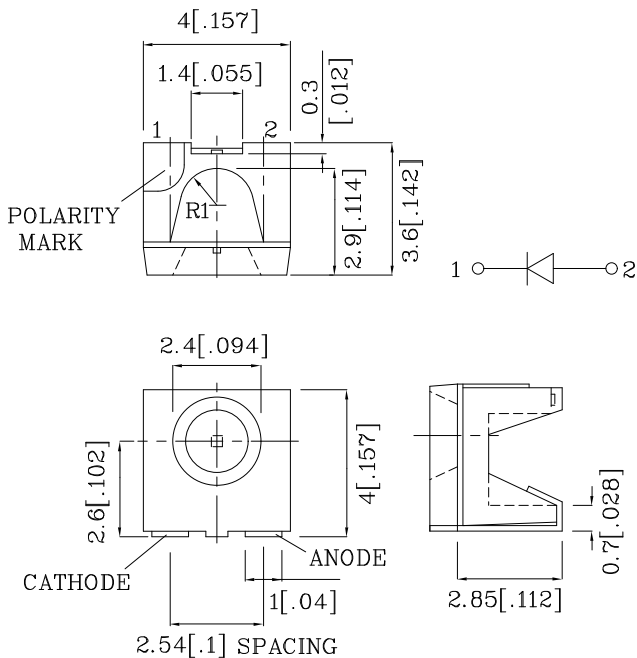
- SINGLE COLOR.
- SUITABLE FOR ALL SMT ASSEMBLY AND SOLDER PROCESS.
- AVAILABLE ON TAPE AND REEL.
- IDEAL FOR BACKLIGHTING.
- PACKAGE : 500PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 4.
- RoHS COMPLIANT.



Notes:

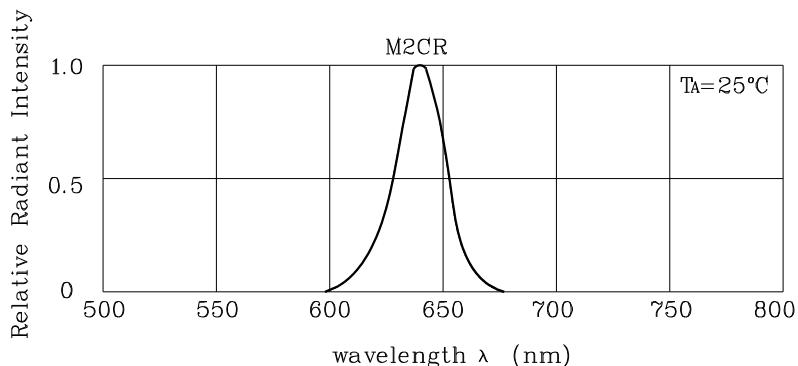
1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.
- 3.Specifications are subject to change without notice.

Absolute Maximum Ratings (TA=25°C)		M2CR (AlInGaP)	Unit
Reverse Voltage	V _R	5	V
Forward Current	I _F	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i _{FS}	150	mA
Power Dissipation	P _T	84	mW
Operating Temperature	T _A	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40 ~ +85	



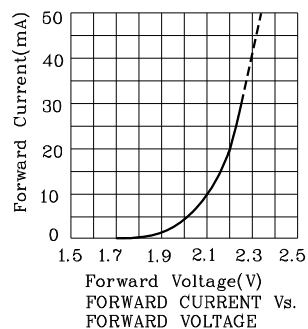
Operating Characteristics (TA=25°C)		M2CR (AlInGaP)	Unit
Forward Voltage (Typ.) (I _F =20mA)	V _F	2.2	V
Forward Voltage (Max.) (I _F =20mA)	V _F	2.8	V
Reverse Current (Max.) (V _R =5V)	I _R	10	uA
Wavelength of Peak Emission (Typ.) (I _F =20mA)	λ P	640	nm
Wavelength of Dominant Emission (Typ.) (I _F =20mA)	λ D	630	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	Δλ	25	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	C	27	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=20mA) mcd	Wavelength nm λ P	Viewing Angle 2 θ 1/2	
				min.	typ.		
ZM2CR67W	Red	AlInGaP	Water Clear	480	995	640	90°
Published Date : FEB 27,2008		Drawing No :SDSA6294		V1	Checked : B.L.LIU		P.1/4

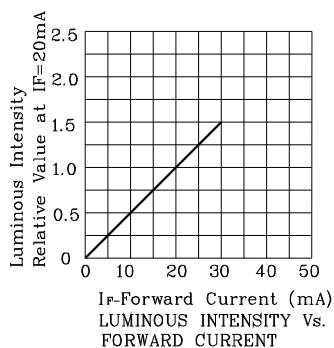


RELATIVE INTENSITY Vs. WAVELENGTH

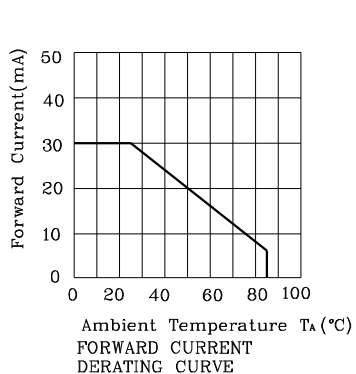
❖ **M2CR**



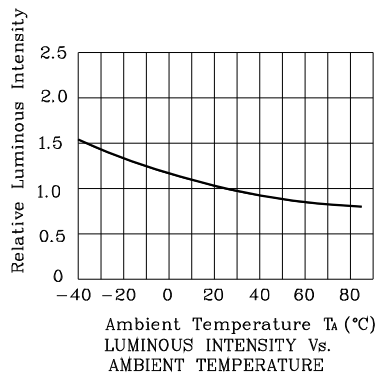
FORWARD CURRENT Vs. FORWARD VOLTAGE



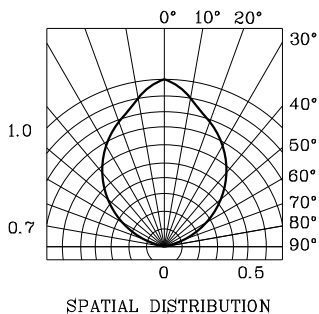
LUMINOUS INTENSITY Vs. FORWARD CURRENT



DERATING CURVE

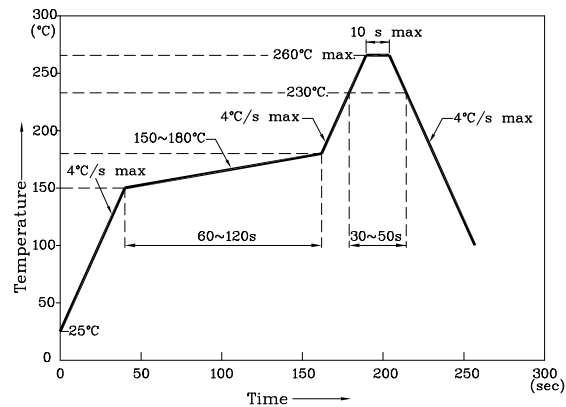


LUMINOUS INTENSITY Vs. AMBIENT TEMPERATURE



SPATIAL DISTRIBUTION

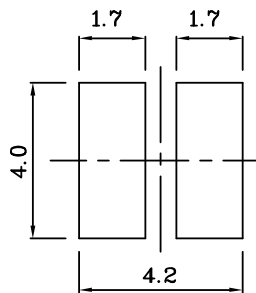
Reflow Soldering Profile For Lead-free SMT Process.



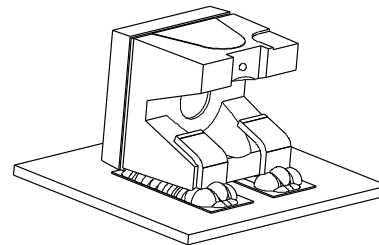
NOTES:

1. Maximum soldering temperature should not exceed 260°C.
2. Recommended reflow temperature: 145°C~260°C.
3. Do not put stress to the epoxy resin during high temperatures conditions.

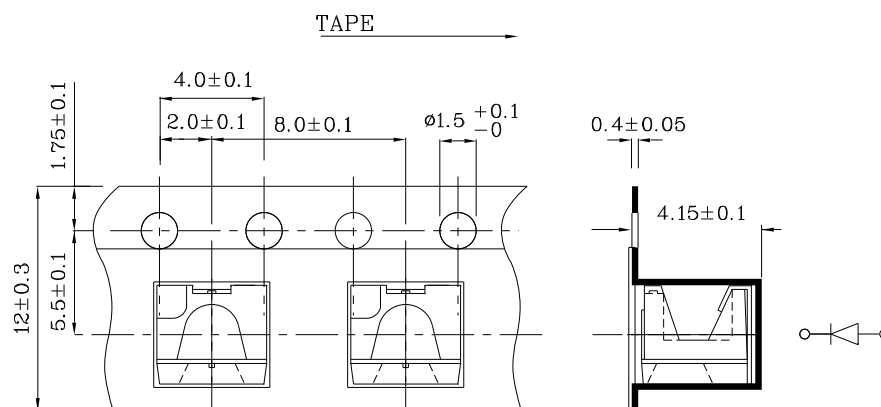
❖ Recommended Soldering Pattern
(Units : mm;Tolerance:± 0.1)



❖ The device has a single mounting surface. The device must be mounted according to the specifications.



❖ Tape Specification (Units : mm)



Remarks:

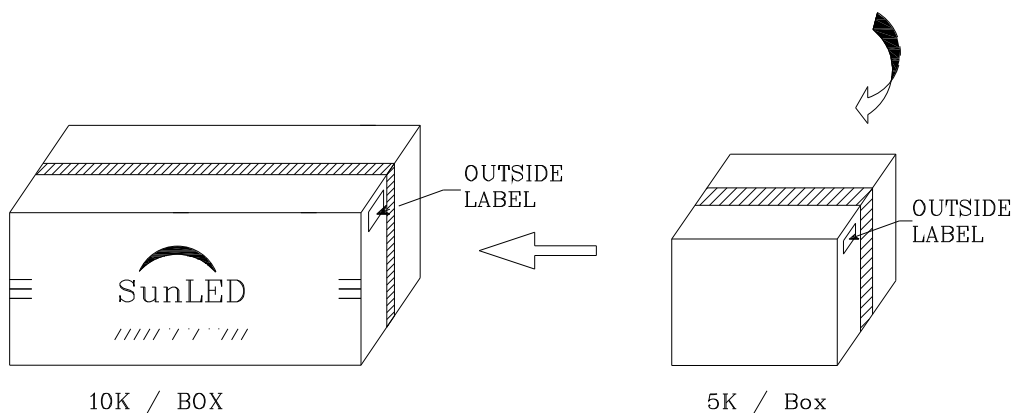
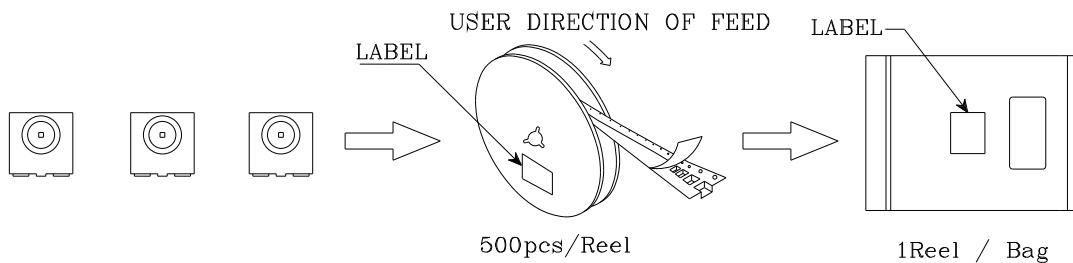
If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux or wavelength), the typical accuracy of the sorting process is as follows:

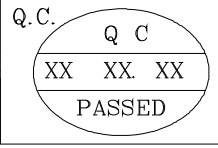
1. Wavelength: +/-1nm
2. Luminous Intensity / Luminous Flux: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

PACKING & LABEL SPECIFICATIONS

ZM2CR67W



		
P/NO : Zxx67x		
QTY : 500 pcs		CODE: XXX
S/N : XX		
LOT NO:  xxxxxxxxxxxxxxxxxxxxxxxx		
RoHS Compliant		